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**Product data sheet** 

## 1. General description

Silicon Carbide Schottky diode with super-low capacitance in a SOD59A (TO-220AC) plastic package, designed for high frequency switched-mode power supplies.

### 2. Features and benefits

- · Super low capacitance and recovery charge
- · Highly stable switching performance
- High forward surge capability IFSM
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

## 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

## 4. Quick reference data

### Table 1. Quick reference data

Parameter	Conditions	N	lin	Тур	Max	Unit
repetitive peak reverse voltage		-		-	650	V
average forward current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 87 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-		-	10	Α
junction temperature		-		-	175	°C
acteristics						
forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>	-		1.65	1.85	V
	I <sub>F</sub> = 10 A; T <sub>i</sub> = 150 °C; <u>Fig. 5</u>	-		2.1	2.5	V
	repetitive peak reverse voltage average forward current junction temperature	repetitive peak reverse voltage	repetitive peak reverse voltage $ \begin{array}{c} \text{repetitive peak reverse} \\ \text{average forward} \\ \text{current} \\ \text{junction temperature} \\ \text{forward voltage} \\ \end{array} \begin{array}{c} \delta = 0.5 \; ; T_{mb} \leq 87 \; ^{\circ}\text{C}; \text{ square-wave} \\ \text{pulse; Fig. 1; Fig. 2; Fig. 3} \\ \text{-} \\ \text$	repetitive peak reverse voltage $ \begin{array}{ccccccccccccccccccccccccccccccccccc$	repetitive peak reverse voltage $ \begin{array}{ccccccccccccccccccccccccccccccccccc$	repetitive peak reverse voltage $-$ - 650 average forward $\delta = 0.5$ ; $T_{mb} \le 87$ °C; square-wave current pulse; Fig. 1; Fig. 2; Fig. 3 $-$ - 175 acteristics $-$ - 1.65 1.85

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Q <sub>r</sub>	recovered charge	$I_F = 10 \text{ A; } dI_F/dt = 500 \text{ A/}\mu\text{s;}$ $V_R = 400 \text{ V; } T_j = 25 \text{ °C; } Fig. 6$	-	12	-	nC

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	K — A
2	Α	anode	)	001aaa020
mb	mb	mounting base; connected to cathode	TO-220AC (SOD59A)	

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package		
	Name	Description	Version
NXPLQSC10650	TO-220AC	Plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59A

# 7. Marking

### **Table 4. Marking codes**

Type number	Marking code
NXPLQSC10650	NXPLQSC10650

# 8. Limiting values

## **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	650	V
$V_{RWM}$	crest working reverse voltage		-	650	V
$V_R$	reverse voltage	DC	-	650	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; T <sub>mb</sub> ≤ 87 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	10	Α
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 ; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 87 °C; squarewave pulse	-	20	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	-	52	А
		$t_p$ = 10 $\mu$ s; $T_{j(init)}$ = 25 °C; square-wave pulse	-	385	Α
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-	175	°C

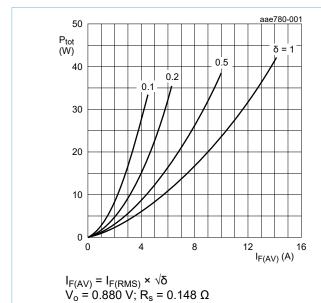


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

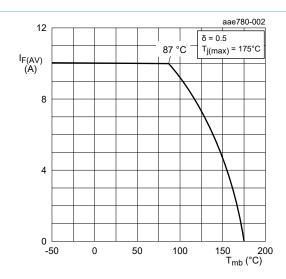
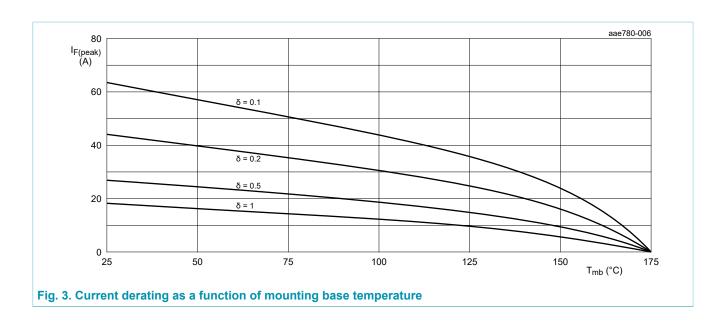


Fig. 2. Forward current as a function of mounting base temperature; maximum values



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## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. 4	-	-	2.3	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

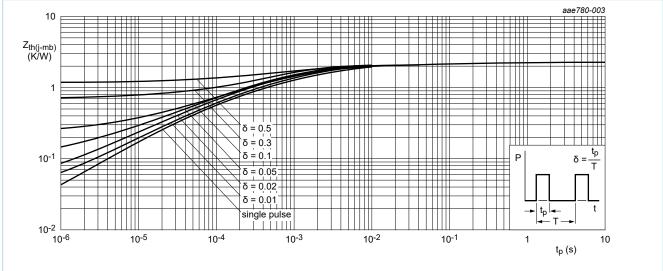


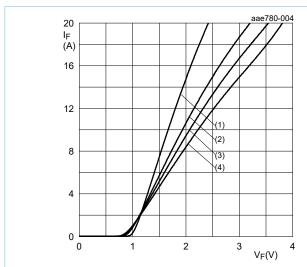
Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

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## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics				,	
$V_{F}$	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>	-	1.65	1.85	V
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>	-	2.1	2.5	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 650 V; T <sub>j</sub> = 25 °C	-	-	230	μΑ
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 150 °C	-	-	700	μΑ
Dynamic cl	haracteristics					
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 10 A; dI <sub>F</sub> /dt = 500 A/μs; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	12	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C	-	250	-	pF
		f = 1 MHz; V <sub>R</sub> = 300 V; T <sub>j</sub> = 25 °C	-	26	-	pF
		f = 1 MHz; V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	21	-	pF



 $V_o = 0.880 \text{ V}; R_s = 0.148 \Omega$ 

(1)  $T_j = 25$  °C; typical values (2)  $T_j = 100$  °C; typical values (3)  $T_j = 150$  °C; typical values (4)  $T_j = 175$  °C; typical values



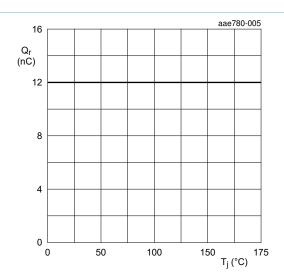
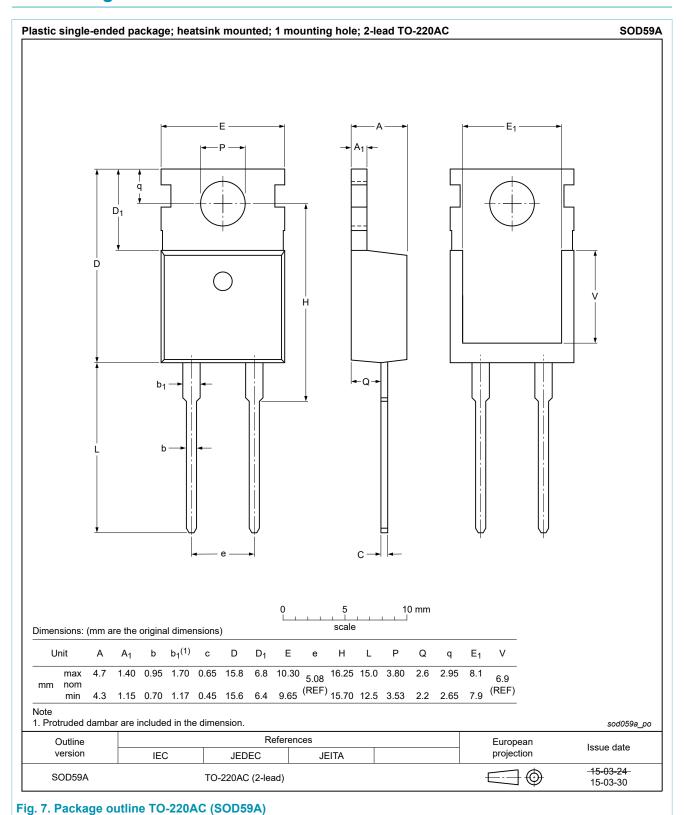


Fig. 6. Recovered charge as a function of junction temperature

# 11. Package outline



# 12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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